



Intel® 500 Series Chipset Family On-Package Platform Controller Hub (PCH)

Specification Update

July 2022

Revision 015



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Revision History

Document Number	Revision Number	Description	Revision Date
630747	015	<ul style="list-style-type: none">• Updated<ul style="list-style-type: none">– Erratum20 - USB Audio Offload Traffic with Full-Speed Device Behind Hub• Added<ul style="list-style-type: none">– Erratum 31 - USB 3.2 Gen 1x1 Port Does Not Send 16 Polling LFPS Burst– Erratum 32 - eSPI SCI Interrupt Virtual Wire Packets During S0i3 Substates Exit– Erratum 33 - G3 Current Specification on VCCRTC Rail– Erratum 34 - Timed GPIO Event May Have a Mismatched Time Stamp– Specification Clarification 4 - VCCRTC Voltage Requirement for G3 and Non-G3 State	July 2022
630747	014	<ul style="list-style-type: none">• Updated<ul style="list-style-type: none">– PCH type and stepping info in the Errata Summary table– Specification Clarification 1 - SX_EXIT_HOLDOFF# Not Functional with eSPI Enabled• Removed<ul style="list-style-type: none">– Identification Information chapter	June 2022
630747	013	<ul style="list-style-type: none">• Added<ul style="list-style-type: none">– Erratum26 - USB 2.0 Device Interrupt IN Endpoint Split Transaction Error– Erratum27 - Processor C-States with USB Full-speed or Low-speed Device Hotplug– Erratum28 - Leakage Current from VCCPRIM_1P8 Power Rail– Erratum29 - Incorrect MSI BDF Returned By Touch Host Controller– Erratum30 - System Hang During G3 Exit Following RTC Reset	February 2022
630747	012	<ul style="list-style-type: none">• Updated<ul style="list-style-type: none">– C0 stepping info in Identification Information chapter– C0 stepping info in Errata Summary table	December 2021
630747	011	<ul style="list-style-type: none">• Added<ul style="list-style-type: none">– Identification Information chapter– Server Intel® Chipset C256 and C252 identification– Erratum21 - SLP_A# Minimum Assertion Width Timer During G3 Exit	November 2021

		<ul style="list-style-type: none"> - Erratum22 - PCH Thermal Subsystem Not Updated After S0ix Exit - Erratum23 - Intel CSME and PMC Power State Transitions - Erratum24 - xHCI Force Header Command Incorrect Return Code - Erratum25 - Unexpected S4 Wake Event with a Self-Powered Thunderbolt Device <ul style="list-style-type: none"> • Updated <ul style="list-style-type: none"> - Erratum20 - USB Audio Offload Traffic with Full-Speed Device Behind Hub 	
630747	010	<ul style="list-style-type: none"> • Removed <ul style="list-style-type: none"> - Erratum19 - Host Partition Reset Timeout with Delayed Authentication Mode (DAM) Capability Enabled 	September 2021
630747	009	<ul style="list-style-type: none"> • Added <ul style="list-style-type: none"> - Erratum19 - Host Partition Reset Timeout with Delayed Authentication Mode (DAM) Capability Enabled - Erratum20 - USB Audio Offload Traffic with Full-Speed Device Behind Hub 	September 2021
630747	008	<ul style="list-style-type: none"> • Updated <ul style="list-style-type: none"> - xHCI D3 Exit Timing Spec Clarification 	July 2021
630747	007	<ul style="list-style-type: none"> • Added <ul style="list-style-type: none"> - FIVR Transitions During Deep Sx Entry with Integrated GbE Enabled - Ring Oscillator Calibration - xHCI D3 Exit Timing Spec Clarification • Updated <ul style="list-style-type: none"> - PCIe* Clock and PCIe Reference Clock to Processor Maximum Rising/Falling Edge Rate and V_{CROSS} 	July 2021
630747	006	<ul style="list-style-type: none"> • Added <ul style="list-style-type: none"> - USB VTIO Device Capabilities Field Length 	June 2020
630747	005	<ul style="list-style-type: none"> • Added <ul style="list-style-type: none"> - Integrated GbE Controller Reset on D3 Exit - PCIe Clock Maximum Rising/Falling Edge Rate and V_{CROSS} - SATA Controller Support for Automatic Partial to Slumber Transition (APST) Feature 	January 2021
630747	004	<ul style="list-style-type: none"> • Added <ul style="list-style-type: none"> - PCH and Processor Sync Error During C8 Entry 	December 2020
630747	003	<ul style="list-style-type: none"> • Added <ul style="list-style-type: none"> - SX_EXIT_HOLDOFF# Not Functional with eSPI Enabled 	November 2020
630747	002	<ul style="list-style-type: none"> • Added <ul style="list-style-type: none"> - Unexpected Shutdown with VCCIN_AUX Retention Mode Enabled 	October 2020



		<ul style="list-style-type: none">- Time-Sensitive Networking Incorrectly Advertised RX FIFO Size (for IoT Platforms only)- xHCI Serial Bus Release Number Version	
630747	001	Initial Release	August 2020

1 Preface

This document is an update to the specifications contained in the documents listed in the following [Affected Documents](#) table. This document is a compilation of device and document errata, and specification clarifications, and changes. It is intended for hardware system manufacturers and for software developers of applications, operating system, and tools.

Information types defined in the nomenclature section of this document are consolidated into the specification update and are no longer published in other documents.

This document may also contain information that has not been previously published.

1.1 Affected Documents

Document Title	Document Number
Intel® 500 Series Chipset Family On-Package Platform Controller Hub (PCH) Datasheet, Volume 1 of 2	631119
Intel® 500 Series Chipset Family On-Package Platform Controller Hub (PCH) Datasheet, Volume 2 of 2	631120
11th Generation Intel® Core™ Processor Family for IoT Platforms Datasheet Addendum	632133
Intel® 500 Series Chipset Family On-Package Platform Controller Hub (PCH) Electrical and Thermal Specifications	615134

1.2 Nomenclature

Errata are design defects or errors. Errata may cause the behavior of the PCH to deviate from published specifications. Hardware and software designed to be used with any given stepping must assume that all errata documented for that stepping are present in all devices.

Specification Changes are modifications to the current published specifications. These changes will be incorporated in any new release of the specification.

Specification Clarifications describe a specification in greater detail or further highlight a specification's impact to a complex design situation. These clarifications will be incorporated in the next release of the specifications.



2 Summary Tables of Changes

The following tables indicate the Specification Changes, Errata, Specification Clarifications or Documentation Changes, which apply to the product. Intel may fix some of the errata in a future stepping of the component and account for the other outstanding issues through documentation or specification changes as noted. These tables use the following notations:

2.1 Codes Used in Summary Table

Stepping	Description
X	Erratum exists in the stepping indicated. Specification Change that applies to the stepping indicated.
(No mark) or (Blank Box)	This erratum is fixed or not applicable in listed stepping or Specification Change does not apply to listed stepping.

Status	Description
Doc	Document change or update that is implemented.
Planned Fix	This erratum may be fixed in a future stepping of the product.
Fixed	This erratum has been previously fixed in Intel® hardware, firmware, or software.
No Fix	There are no plans to fix this erratum.

2.2 Errata Summary Table

Erratum ID	PCH Stepping		Errata
	B0	C0	
1	No Fix		USB DbC Or Device Mode Port When Resuming From S3, S4, S5, or G3 State
2	No Fix		xHCI Power Management Link Timer
3	No Fix		xHCI USB 2.0 ISOCH Device Missed Service Interval
4	No Fix		SPI SFDP Program Suspend And Program Resume Instruction Fields Not Used
5	No Fix		Intel® Trace Hub Pipe Line Empty
6	No Fix		xHCI Short Packet Event Using Non-Event Data TRB
7	No Fix		eSPI SBLCL Register Bit Not Cleared By PLTRST#
8	No Fix		xHCI Protocol Speed ID Count Field
9	No Fix		S0ix Entry When Connecting a USB-C* Power Adapter
10	No Fix		Unexpected Shutdown with VCCIN_AUX Retention Mode Enabled
11	No Fix		Time-Sensitive Networking Incorrectly Advertised RX FIFO Size (for IoT Platforms only)
12	No Fix		xHCI Serial Bus Release Number Version
13	Fixed		PCH and Processor Sync Error During C8 Entry
14	No Fix		Integrated GbE Controller Reset on D3 Exit
15	No Fix		PCIe Clock and PCIe Reference Clock to Processor Maximum Rising/Falling Edge Rate and V_{CROSS}
16	No Fix		USB VTIO Device Capabilities Field Length
17	Fixed		FIVR Transitions During Deep Sx Entry with Integrated GbE Enabled
18	Fixed		Ring Oscillator Calibration
19	N/A		N/A. Erratum has been removed.



20	No Fix	USB Audio Offload Traffic with Full-Speed Device Behind Hub
21	No Fix	SLP_A# Minimum Assertion Width Timer During G3 Exit
22	Fixed	PCH Thermal Subsystem Not Updated After S0ix Exit
23	Fixed	Intel® CSME and PMC Power State Transitions
24	No Fix	xHCI Force Header Command Incorrect Return Code
25	Fixed	Unexpected S4 Wake Event with a Self-Powered Thunderbolt™ Device
26	Fixed	USB 2.0 Device Interrupt IN Endpoint Split Transaction Error
27	No Fix	Processor C-States with USB Full-speed or Low-speed Device Hotplug
28	No Fix	Leakage Current from VCCPRIM_1P8 Power Rail
29	Fixed	Incorrect MSI BDF Returned By Touch Host Controller
30	Fixed	System Hang During G3 Exit Following RTC Reset
31	No Fix	USB 3.2 Gen 1x1 Port Does Not Send 16 Polling LFPS Burst
32	No Fix	eSPI SCI Interrupt Virtual Wire Packets During S0i3 Substates Exit
33	No Fix	G3 Current Specification on VCCRRTC Rail
34	No Fix	Timed GPIO Event May Have a Mismatched Time Stamp

2.3 Specification Changes

No.	Specification Changes
	No specification changes for this revision of the specification update.

2.4 Specification Clarifications

No.	Specification Clarifications
1	SX_EXIT_HOLDOFF# Not Functional with eSPI Enabled
2	SATA Controller Support for Automatic Partial to Slumber Transition (APST) Feature
3	xHCI D3 Exit Timing
4	VCCRTC Voltage Requirement for G3 and Non-G3 State

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3 Errata Details

1	USB DbC Or Device Mode Port When Resuming From S3, S4, S5, or G3 State
Problem	<p>If a PCH USB 3.2 Type-C port is configured in Device Mode (or in DbC mode) and connected to an external USB 3.2 host controller, it may cause the USB port to go into a non-functional state in the following scenarios:</p> <ol style="list-style-type: none"> 1. The PCH resumes from S3, S4, or S5 state, the port may remain in U2. 2. The port is connected to a USB 3.2 Gen 1x1 host controller when resuming from S3, S4, S5, or G3, the port may enter into Compliance Mode or an inactive state if Compliance mode is disabled. 3. The port is connected to a USB 3.2 Gen 2x1 host controller when resuming from S3, S4, S5, or G3, the port may enter an inactive state.
Implication	PCH USB Type-C port configured in Device Mode (or in DbC mode) may fail to enumerate or become unavailable.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

2	xHCI Power Management Link Timer
Problem	The xHCI implements the Power Management Link Timer (PM LC Timer) Timeout value as 10 us instead of 4 us as defined by the USB 3.2 specification.
Implication	<p>USB-IF xHCI CV TD 7.21 may report a failure. Intel has obtained a waiver for TD 7.21.</p> <p>Note: No functional issues are expected.</p>
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

3	xHCI USB 2.0 ISOCH Device Missed Service Interval
Problem	When the xHCI controller is stressed with concurrent traffic across multiple USB ports, the xHCI controller may fail to service USB 2.0 Isochronous IN endpoints within the required service interval.
Implication	<p>USB 2.0 isochronous devices connected to the xHCI controller may experience dropped packets.</p> <p>Note: This issue has only been observed in a synthetic environment.</p>
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

4	SPI SFDP Program Suspend And Program Resume Instruction Fields Not Used
Problem	For flash device suspend/resume opcodes, the SPI controller does not use JEDEC SFDPs 13th DWORD bits [15:0], Program Suspend Instruction and Program Resume Instruction fields. The controller only uses bits [31:16], Suspend Instruction and Resume Instruction fields, to obtain the suspend/resume opcodes.
Implication	If the SPI flash requires bits [15:0] to be different than bits [31:16], then the suspend/resume feature is not functional. In this case, system behavior varies depending on what the suspend/resume instruction is and when it is generated. Note: Major flash vendors have been using the same value for bits [31:16] and bits [15:0].
Workaround	None identified. If a device requires bits [15:0] to be different than bits [31:16], then disable the device suspend / resume via the SPI Suspend / Resume Enable soft strap.
Status	For the steppings affected, refer to the Summary Table of Changes .

5	Intel® Trace Hub Pipe Line Empty
Problem	The Intel® Trace Hub Pipe Line Empty bit (CSR_MTB_BAR, Offset D4h) for a given output port may be set while the Input Buffer Empty for the associated output port is not set. This will only happen when the captureDone signal is de-asserted by clearing the ForceCaptureDone bit (CSR_MTB_BAR, Offset D8h) is cleared or the StoreQual[0] signal is de-asserted by the Trigger Unit before the pipe line is empty, and the destination is either system memory or USB (DCI).
Implication	There may be valid trace data in the trace source input buffer which did not get sent to the destination (output port).
Workaround	None identified. CaptureDone should be cleared or de-asserted after the pipe line is empty.
Status	For the steppings affected, refer to the Summary Table of Changes .

6	xHCI Short Packet Event Using Non-Event Data TRB
Problem	The xHCI may generate an unexpected short packet event for the last transfer's Transfer Request Block (TRB) when using Non-Event Data TRB with multiples TRBs.
Implication	Transfer may fail due to the packet size error. Note: This issue has only been observed in a synthetic environment. No known implication has been identified with commercial software.
Workaround	None identified. Intel recommends software to use Data Event TRBs for short packet completion.
Status	For the steppings affected, refer to the Summary Table of Changes .

7	eSPI SBLCL Register Bit Not Cleared By PLTRST#
Problem	The IOSF-SB eSPI Link Configuration Lock (SBLCL) bit (offset 4000h, bit 27 in eSPI PCRspace) is reset by RSMRST# assertion instead of PLTRST# assertion.
Implication	If the SBLCL bit is set to 1, software will not be able to access the eSPI device Capabilities and Configuration register in the reserved address range (0h - 7FFh) until RSMRST# asserts.
Workaround	None identified. If software needs to access the eSPI device reserved range 0h - 7FFh while SBLCL bit is set to 1, a RSMRST# assertion should be performed.
Status	For the steppings affected, refer to the Summary Table of Changes .

8	xHCI Protocol Speed ID Count Field
Problem	The xHCI Host Controller reports an incorrect Protocol Speed ID Count value for the USB 3.2 Supported Protocol Capability register - xHCI MMIO offset 8028 bits [31:28].
Implication	USB-IF xHCI CV TD 1.9 may report a failure. Note: No functional impact is expected.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

9	S0ix Entry When Connecting a USB-C* Power Adapter
Problem	Connecting a USB-C* power adapter to a PCH USB port may cause a race condition that can prevent the system from entering S0ix. This issue only occurs on designs where the USB-C Power Delivery (PD) implements Out Of Band (OOB) messaging to communicate with the PCH for port mapping.
Implication	The system may fail to enter S0ix.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

10	Unexpected Shutdown with VCCIN_AUX Retention Mode Enabled
Problem	Due to a PMC logic bug, the FIVR may unexpectedly shutdown during C10 exit when retention mode is enabled for VCCIN_AUX.
Implication	The system may unexpectedly shut down and requires a global reset cycle to recover.
Workaround	None identified. Due to this erratum, VCCIN_AUX retention mode is not supported and should be disabled. BIOS Reference Code Revision 3357.02 or later disables VCCIN_AUX retention mode by default.
Status	For the steppings affected, refer to the Summary Table of Changes .

11	Time-Sensitive Networking Incorrectly Advertised RX FIFO Size (for IoT Platforms only)
Problem	The Time-Sensitive Networking (TSN) controller MTL Receive FIFO Size (RXFIFOSIZE) bits [4:0] in register MAC_HW_FEATURE1 (MMIO offset 120h) advertises 32 KB as the allowable RX FIFO size, while the implemented size is 24 KB.
Implication	The maximum aggregate size for MTL RX queues is 24 KB. If software allocation of RX queues exceeds this amount, then data attempted to be queued greater than 24 KB will be lost.
Workaround	None identified. Software should not allocate an aggregate size of more than 24 KB for MTL RX queues.
Status	For the steppings affected, refer to the Summary Table of Changes .

12	xHCI Serial Bus Release Number Version
Problem	The xHCI Host Controller reports the value of 31h for the Serial Bus Release Number (SBRN) register (offset 60h), which does not meet the xHCI specification revision 1.2.
Implication	USB-IF xHCI CV TD 1.1 may report a failure. Intel has obtained a waiver for TD 1.1. Note: There are no known functional failures due to this erratum.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

13	PCH and Processor Sync Error During C8 Entry
Problem	Due to an Internal PMC logic issue, the PCH and processor may become out of sync during C8 entry flow.
Implication	The system may hang.
Workaround	It is possible for the BIOS to contain a workaround for this erratum.
Status	For the steppings affected, refer to the Summary Table of Changes .

14	Integrated GbE Controller Reset on D3 Exit
Problem	Upon GbE controller D3 exit, the GbE host driver performs a controller reset. During this reset, software accesses to the GbE MMIO registers may not complete.
Implication	The system may hang. Note: This erratum has only been observed in a synthetic environment.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

15	PCIe Clock and PCIe Reference Clock to Processor Maximum Rising/Falling Edge Rate and V_{CROSS}
Problem	The PCIe Clock Output signals (CLKOUT_PCIE_P/N) and PCIe reference clock signals to processor (CLKOUT_CPUPCIBCLK_P/N) may not meet the maximum Rising/Falling Edge Rate and V_{CROSS} specifications as defined in the PCI Express Card Electromechanical Specification Revision 3.0, section 2.1.3, REFCLK AC Specifications.
Implication	There are no known functional failures due to this erratum.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

16	USB VTIO Device Capabilities Field Length
Problem	The xHCI spec version 1.2 defines the PCI Express Capability structure offset 04h Device Capabilities (DVSEC) field to be 8 bytes. The USB Virtualization Based Trusted IO (VTIO) Management controller implements the DVSEC field as 12 bytes.
Implication	A USB controller driver may not be able to enable the USB VTIO controller.
Workaround	None identified. To mitigate this erratum, an Independent Software Vendor could account for the field length in the USB controller driver.
Status	For the steppings affected, refer to the Summary Table of Changes .

17	FIVR Transitions During Deep Sx Entry with Integrated GbE Enabled
Problem	During Deep Sx entry, if ACPRESENT is asserted during the SUSWARN# / SUSACK# handshake, PMC FW may prematurely transition FIVR to a deeper power state before determining Integrated GbE presence. This issue occurs only on platforms with Integrated GbE.
Implication	The system may hang during Deep Sx entry.
Workaround	A BIOS code change has been identified and may be implemented as a workaround for this erratum.
Status	For the steppings affected, refer to the Summary Table of Changes .

18	Ring Oscillator Calibration
Problem	The PCH contains a ring oscillator calibration circuit to stabilize internal clocks across voltage and temperature changes. During operation, noise from the calibration circuit may cause the PCH internal clocks to deviate from expected frequency.
Implication	If the PCH internal clocks deviate from expected frequency, several unexpected behaviors may occur including system shutdown, system hang, or device detection issues.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

19	N/A. Erratum has been removed.
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20	USB Audio Offload Traffic with Full-Speed Device Behind Hub
Problem	If USB audio offload is enabled for a USB Full-Speed Isochronous audio device connected behind a USB 2.0 or later hub, and there is an active concurrent bulk transfer to another device on any port of the xHCI controller or behind the hub, the controller may stall the offloaded audio traffic and a split transaction error may occur.
Implication	The USB audio offload playback may stop. Audio may be recovered if the audio stream is paused and restarted, the audio device is removed and reconnected, or the audio application is restarted.
Workaround	None identified. A mitigation for this erratum is available with Intel® Smart Sound Technology version 10.29.00.5574 or later for systems with Microsoft Windows* 11 OS Release, or Intel Smart Sound Technology version 10.29.00.7767 or later for systems with Microsoft Windows 10 OS Release. This mitigation will disable audio offload functionality for USB audio devices connected behind a hub.
Status	For the steppings affected, refer to the Summary Table of Changes .

21	SLP_A# Minimum Assertion Width Timer During G3 Exit
Problem	Setting the Disable SLP_X Stretching After SUS Well Power Up (DIS_SLP_X_STRCH_SUS_UP) bit (offset 1020h, bit 12 in PMC_MMIO space) to 1 does not disable the SLP_A# Minimum Assertion Width (SLP_A_MIN_ASST_WDTH) timer (offset 1020h, bit 17 and 16 in PMC_MMIO space).
Implication	G3 exit duration may be extended by the value programmed in the SLP_A_MIN_ASST_WDTH register.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

22	PCH Thermal Subsystem Not Updated After S0ix Exit
Problem	The PMC firmware may not correctly re-enable the PCH thermal subsystem after S0ix exit.
Implication	The temperature used by the PCH thermal subsystem may not updated. This may result in incorrect temperature reporting or thermal throttling. Catastrophic temperature event handling is not impacted by this erratum.
Workaround	A BIOS code change has been identified and may be implemented as a workaround for this erratum.
Status	For the steppings affected, refer to the Summary Table of Changes .

23	Intel® CSME and PMC Power State Transitions
Problem	The PMC and Intel® CSME state machines may become out of sync during Intel® CSME M3 to M-OFF power state transitions.
Implication	The system may hang and require a global reset to recover.
Workaround	A BIOS code change has been identified and may be implemented as a workaround for this erratum.
Status	For the steppings affected, refer to the Summary Table of Changes .

24	xHCI Force Header Command Incorrect Return Code
Problem	The xHCI controller does not return the correct completion code for the Force Header Command as defined in the Section 4.6.16 of the eXtensible Host Controller Interface for Universal Serial Bus (xHCI) Requirements Specification Rev 1.2.
Implication	xHCI CV TD4.12 - Force Header Command Test may report an error. Intel has obtained a waiver for TD 4.12. The Force Header Command is only used by the USBIF Command Verifier (xHCI CV) tool for device testing. There are no known functional failures due to this erratum.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

25	Unexpected S4 Wake Event with a Self-Powered Thunderbolt™ Device
Problem	The PMC firmware may incorrectly reconfigure the GPIO function mode for the LSx/SBU signals on all integrated Thunderbolt™ 4 USB-C ports if a disconnect event occurs on any integrated Thunderbolt 4 port during S4 entry.
Implication	The change in the LSx signal configuration may cause a self-powered Thunderbolt™ device to unexpectedly wake the system from S4. Note: This erratum is only observed with a self-powered Thunderbolt device connected to an integrated Thunderbolt™ 4 USB-C port.
Workaround	A BIOS code change has been identified and may be implemented as a workaround for this erratum.
Status	For the steppings affected, refer to the Summary Table of Changes .

26	USB 2.0 Device Interrupt IN Endpoint Split Transaction Error
Problem	When a USB Full-speed or Low-speed (with an Interrupt IN Endpoint) device is connected behind a USB hub, and a USB bulk device is also connected to any port on the xHCI controller, a split transaction error may occur on the USB Full-speed or Low-speed device.
Implication	The USB Controller driver may reset the USB Full-speed or Low-speed Interrupt IN Endpoint. The observed behavior is USB device specific. For example, a delay in response may be observed from a Low-speed USB mouse or keyboard device.
Workaround	A BIOS code change has been identified and may be implemented as a workaround for this erratum.

	For a more power optimized solution, a xHCI controller driver may dynamically clear the xHCI MMIO offset 0x8144 bit 8 when a USB Full-speed or Low-speed device is not connected behind a USB Hub and ensure the bit is set as configured by the BIOS.
Status	For the steppings affected, refer to the Summary Table of Changes .

27	Processor C-States with USB Full-speed or Low-speed Device Hotplug
Problem	When doing a hotplug on a USB hub with two or more USB Full-speed or Low-speed devices each with a 1 ms service interval interrupt endpoint, a race condition may occur between the PMC and the xHCI controller.
Implication	The processor may fail to enter C3 or deeper package C-States. Note: This erratum is only observed in a synthetic environment.
Workaround	None identified. This condition is recovered after the xHCI controller has successfully entered D3.
Status	For the steppings affected, refer to the Summary Table of Changes .

28	Leakage Current from VCCPRIM_1P8 Power Rail
Problem	When the VCCPRIM_1P8 is off and the VCCPRIM_3P3 is powered on during G3 to S5, there may be a leakage current from the VCCPRIM_3P3 power rail to VCCPRIM_1P8 power rail.
Implication	The leakage voltage may be observed on VCCPRIM_1P8 power rail. There is no known functional or reliability impact.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

29	Incorrect MSI BDF Returned By Touch Host Controller
Problem	When a hypervisor is enabled, the Message Signaled Interrupt for the Touch Host Controller (THC) returns an incorrect bus device function number.
Implication	The THC may not function properly.
Workaround	A fix has been identified for this erratum and may be available in a software update.
Status	For the steppings affected, refer to the Summary Table of Changes .

30	System Hang During G3 Exit Following RTC Reset
Problem	Following a RTC Reset the PCH debug subsystem may enter an unsupported state if Delayed Authentication Mode (DAM) and DCI are disabled. Note: This issue may be observed only from PMC version 150.01.20.1025 to 150.01.20.1029.
Implication	The system may hang while exiting G3 and requires re-flashing the system IFWI to recover.
Workaround	A BIOS code change has been identified and may be implemented as a workaround for this erratum.



Status	For the steppings affected, refer to the Summary Table of Changes .
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31	USB 3.2 Gen 1x1 Port Does Not Send 16 Polling LFPS Burst
Problem	On USB 3.2 Gen 1x1 only capable ports, including ports configured as USB 3.2 Gen 1x1 by soft strap, the xHCI controller may send only 15 LFPS signals instead of a burst of 16 LFPS signals as specified by the USB 3.2 specification.
Implication	There are no known functional implications due to this erratum. LFPS handshake requires the receiver link partner to only detect two LFPS signals. This issue may impact the SuperSpeed compliance test case, which checks for the 16 LFPS burst requirements: TD6.4, TD6.5, and TD7.31.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

32	eSPI SCI Interrupt Virtual Wire Packets During S0i3 Substates Exit
Problem	The eSPI controller may not receive SCI interrupt virtual wire packets (SCI_DESSERT) from EC during S0i3 substates exit flow.
Implication	The system may hang.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

33	G3 Current Specification on VCCRTC Rail
Problem	The PCH VCCRTC current draw during the G3 state may exceed the maximum current specification of 6 μ A, as documented in the <i>Intel® 500 Series Chipset Family On-Package Platform Controller Hub Datasheet – Volume 1 of 2</i> (Document number: 631119).
Implication	PCH units may experience VCCRTC rail current draw during the G3 state up to 8 μ A. Platform implications are platform design specific.
Workaround	None identified.
Status	For the steppings affected, refer to the Summary Table of Changes .

34	Timed GPIO Event May Have a Mismatched Time Stamp
Problem	When a Timed GPIO event is counted in the Event Counter Capture (TGPIOECCV) register (offset 1238h, bits 31 to 0 in PWRMBASE space), the Time Capture (TGPIOTCV) register (offset 1230h, bits 31 to 0 in PWRMBASE space) value is not immediately updated after that event is counted.
Implication	A Timed GPIO event may have a mismatched time stamp.
Workaround	None identified. A Timed GPIO driver can partially mitigate for this erratum by detecting that a TGPIOECCV register change has occurred without a TGPIOTCV register change, and then repeatedly re-read the TGPIOTCV register until a change occurs.
Status	For the steppings affected, refer to the Summary Table of Changes .





4 ***Specification Changes***

There are no specification changes in this revision of the Specification Update.

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5 Specification Clarification

1	SX_EXIT_HOLDOFF# Not Functional with eSPI Enabled
	<p>Add the following note to the <i>Intel® 500 Series Chipset Family On-Package Platform Controller Hub (PCH) Datasheet, Volume 1 of 2 (Document number: 631119)</i> in the SX_EXIT_HOLDOFF# Signal Description in the Power Management chapter Signal Description section:</p> <p>"When eSPI is enabled, the flash sharing functionality using SX_EXIT_HOLDOFF# is not supported, but the pin still functions to hold off Sx exit after SLP_A# de-assertion."</p>

2	SATA Controller Support for Automatic Partial to Slumber Transition (APST) Feature
	<p>Add the following note to the <i>Intel® 500 Series Chipset Family On-Package Platform Controller Hub Datasheet, Volume 2 of 2 (Document number: 631120)</i> in the HBA Capabilities Extended (GHC_CAP2) register summary, bit 2, 'Automatic Partial to Slumber Transitions (APST)' field description section:</p> <p>"BIOS should set this bit to 0 as APST is not supported."</p>

3	xHCI D3 Exit Timing
	<p>Add the following text to the <i>Intel® 500 Series Chipset Family On-Package Platform Controller Hub (PCH) Datasheet Volume 2 of 2 (Document number: 631120)</i> in the Power Management Control/Status (PM_CS) register summary, bits 1:0, 'PowerState (POWERSTATE)' field description section:</p> <p>"Software should wait for 100 ms before requesting the xHCI controller to re-enter D3 after a D3 exit."</p>

4	VCCRTC Voltage Requirement for G3 and Non-G3 State																		
	<p>Update the following table row to the <i>Intel® 500 Series Chipset Family On-Package Platform Controller Hub (PCH) Electrical and Thermal Specifications (Document number: 615134)</i> in the VCCRTC section of Power Rails Spec sheet:</p> <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="text-align: center;">Symbol</th> <th style="text-align: center;">Parameter</th> <th style="text-align: center;">Minimum</th> <th style="text-align: center;">Nominal</th> <th style="text-align: center;">Maximum</th> <th style="text-align: center;">Unit</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">VCCRTC</td> <td style="text-align: center;">RTC Well Supply (non-G3)</td> <td style="text-align: center;">3.135</td> <td style="text-align: center;">3.3</td> <td style="text-align: center;">3.465</td> <td style="text-align: center;">V</td> </tr> <tr> <td style="text-align: center;">VCCRTC</td> <td style="text-align: center;">RTC Well Supply (G3)</td> <td style="text-align: center;">2.0</td> <td style="text-align: center;">3.0</td> <td style="text-align: center;">3.465</td> <td style="text-align: center;">V</td> </tr> </tbody> </table>	Symbol	Parameter	Minimum	Nominal	Maximum	Unit	VCCRTC	RTC Well Supply (non-G3)	3.135	3.3	3.465	V	VCCRTC	RTC Well Supply (G3)	2.0	3.0	3.465	V
Symbol	Parameter	Minimum	Nominal	Maximum	Unit														
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